

6N137

Super High Speed Response OPIC Photocoupler

■ Features

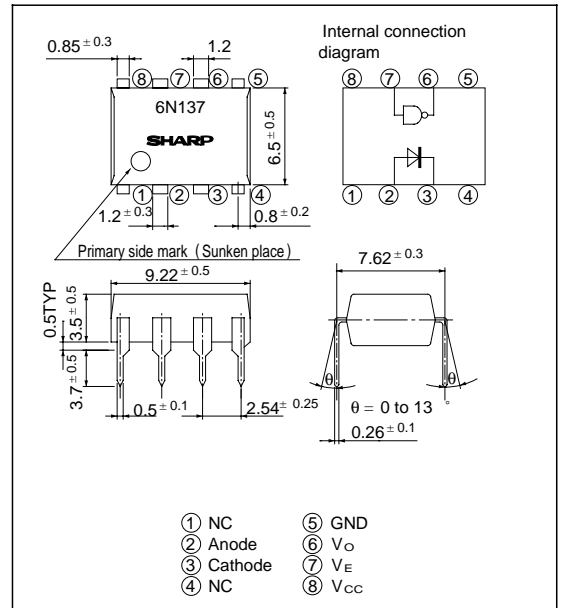
1. Super high speed response
(t_{PHL} , t_{PLH} : TYP. 45ns at $R_L = 350\Omega$)
2. Isolation voltage between input and output
 V_{iso} : 2 500V_{rms}
3. Low input current drive (I_{FHL} : MAX. 5mA)
4. Instantaneous common mode rejection voltage
 CM_H : TYP. 500V/ μ s
5. LSTTL and TTL compatible output
6. Recognized by UL , file No. E64380

■ Applications

1. High speed interfaces for computer peripherals, microcomputer systems
2. High speed line receivers
3. Noise reduction
4. Interfaces for data transmission equipment

■ Outline Dimensions

(Unit : mm)



* " OPIC " (Optical IC) is a trademark of the SHARP Corporation.

An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

■ Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

	Parameter	Symbol	Rating	Unit
Input	*1 Forward current	I_F	20	mA
	*2 Peak forward current	I_{FM}	40	mA
	Reverse voltage	V_R	5	V
Output	Supply voltage	V_{CC}	7	V
	Enable voltage	C_E	5.5	V
	High level output voltage	V_{OIL}	7	V
	Low level output current	I_{OL}	50	mA
	Output collector power dissipation	P_C	85	mW
	*5 Isolation voltage	V_{iso}	2 500	V _{rms}
	Operating temperature	T_{opr}	0 to + 70	$^\circ\text{C}$
	Storage temperature	T_{stg}	- 55 to + 125	$^\circ\text{C}$
	*6 Soldering temperature	T_{sol}	260	$^\circ\text{C}$

*1 $T_a = 0$ to 70°C

*2 Pulse width ≤ 1 ms

*3 For 1 minute MAX.

*4 Not exceed 500mV or more than supply voltage (V_{CC})

*5 AC for 1 minute, 40 to 60% RH

Apply the specific voltage between all the input electrode pins connected together and all the output electrode pins connected together.

*6 2mm or more away from the lead base for 10 seconds

■ Electro-optical Characteristics

(Ta = 0 to + 70°C unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Logic (1) output current	I _{OH}	V _{CC} = 5.5V, V _O = 5.5V, I _F = 250 μA, V _E = 2.0V	-	2	250	μA
Logic (0) output voltage	V _{OL}	V _{CC} = 5.5V, I _F = 5mA, V _{EH} = 2.0V, I _{OL} (Sinking) = 13mA	-	0.4	0.6	V
Logic (1) enable current	I _{EH}	V _{CC} = 5.5V, V _E = 2.0V	-	- 0.8	-	mA
Logic (0) enable current	I _{EL}	V _{CC} = 5.5V, V _E = 0.5V	-	- 1.2	- 2.0	mA
Logic (1) supply current	I _{CCH}	V _{CC} = 5.5V, I _F = 0mA, V _E = 0.5V	-	7	15	mA
Logic (0) supply current	I _{CCL}	V _{CC} = 5.5V, I _F = 10mA, V _E = 0.5V	-	13	18	mA
*1 Leak current	I _{LO}	45% RH, Ta = 25°C, t = 5s, V _{I0} = 3 000V _{dc}	-	-	1.0	mA
*1 Isolation resistance (input-output)	R _{I-O}	V _{I-O} = 500V, Ta = 25°C	-	10 ¹²	-	Ω
*1 Capacitance (input-output)	C _{I-O}	f = 1MHz, Ta = 25°C	-	0.6	-	pF
*2 Input forward voltage	V _F	I _F = 10mA, Ta = 25°C	-	1.6	1.75	V
Input reverse voltage	BV _R	I _R = 10 mA, Ta = 25°C	5	-	-	V
Input capacitance	C _{IN}	V _F = 0, f = 1MHz	-	60	-	pF
*3 Current transfer ratio	CTR	I _F = 5.0mA, R _L = 100Ω	-	700	-	%
*4 Propagation delay time Output (0) → (1)	t _{PLH}	Ta = 25°C, V _{CC} = 5V, R _L = 350Ω, C _L = 15pF, I _F = 7.5mA	-	45	75	ns
*5 Propagation delay time Output (1) → (0)	t _{PHL}	Ta = 25°C, V _{CC} = 5V, R _L = 350Ω, C _L = 15pF, I _F = 7.5mA	-	45	75	ns
Output rise-fall time (10 to 90%)	t _r , t _f	R _L = 350Ω, C _L = 15pF, I _F = 7.5mA	-	20, 30	-	ns
*6 Enable propagation delay time (1) → (0)	t _{ELH}	R _L = 350Ω, C _L = 15pF, I _F = 7.5mA, V _{EH} = 3.0V, V _{EL} = 0.5V	-	40	-	ns
*7 Enable propagation delay time (0) → (1)	t _{EHL}	R _L = 350Ω, C _L = 15pF, I _F = 7.5mA, V _{EH} = 3.0V, V _{EL} = 0.5V	-	15	-	ns
*8 Instantaneous common mode rejection voltage "Output (0)"	CM _H	V _{CM} = 10V, R _L = 350Ω, V _O (min.) = 2V, I _F = 0mA	-	500	-	V/μs
*8 Instantaneous common mode rejection voltage "Output (1)"	CM _L	V _{CM} = 10V, R _L = 350Ω, V _O (max.) = 0.8V, I _F = 5mA	-	- 500	-	V/μs

Note) Typical values are all at V_{CC} = 5V, Ta = 25°C

*1 Measured as 2-pin element. Connect pins 2 and 3, connect pins 5, 6, 7 and 8.

*2 At I_{in} = 10 mA, V_F decreases at the rate of 1.6mV/°C if the temperature goes up.

*3 DC current transfer ratio is defined as the ratio of output collector current to forward bias input current.

*4, *5 Refer to the Fig. 1.

*6, *7 Refer to the Fig. 2.

*8 CM_H represents a common mode voltage ignorable rise time ratio that can hold logic(1) state in output.

CM_L represents a common mode voltage ignorable fall time ratio that can hold logic(0) state in output.

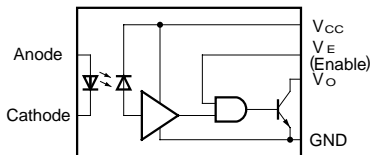
■ Recommended Operating Conditions

Parameter	Symbol	MIN.	MAX.	Unit
Low level input current	I _{FL}	0	250	μA
High level input current	I _{FH}	7.0	15	mA
High level enable voltage	V _{EH}	2.0	V _{CC}	V
Low level enable voltage	V _{EL}	0	0.8	V
Supply voltage	V _{CC}	4.5	5.5	V
Fanout (TTL load)	N	-	8	-
Operating temperature	T _{opr}	0	70	°C

1. No necessary external pull-up resistor to hold enable input at high level

2. Connect a ceramic by-pass capacitor (0.01 to 0.1 μF) between V_{CC} and GND at the position within 1cm from pin.

Circuit Block Diagram



Truth Table

Input	Enable	Output
H	H	L
L	H	H
H	L	H
L	L	H

L:Logic (0) H:Logic (1)

Fig.1 Test Circuit for Propagation Delay time

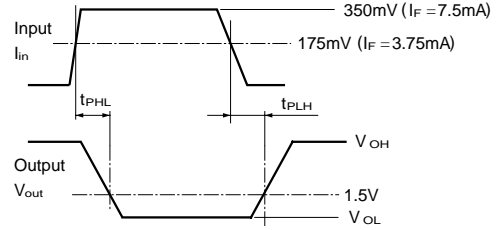
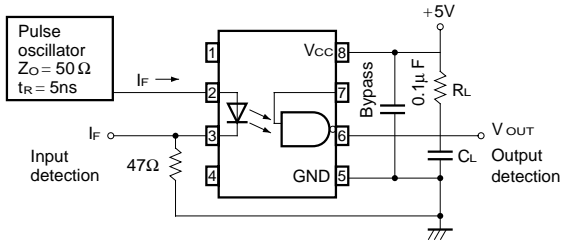


Fig.2 Test Circuit for Enable Propagation Delay Time

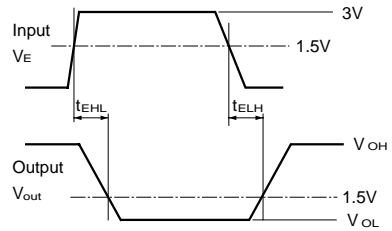
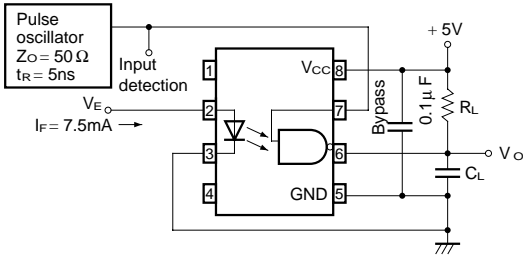


Fig.3 Test Circuit for Instantaneous Common Mode Rejection Voltage

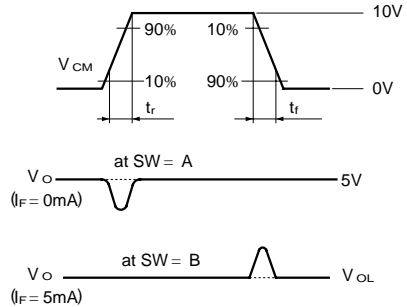
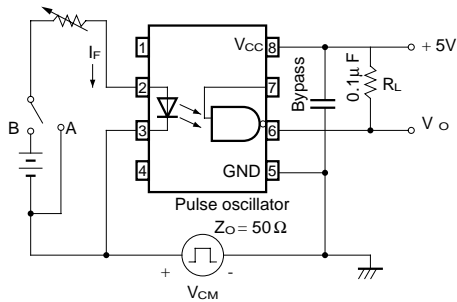


Fig. 4 Output Collector Power Dissipation vs. Ambient Temperature

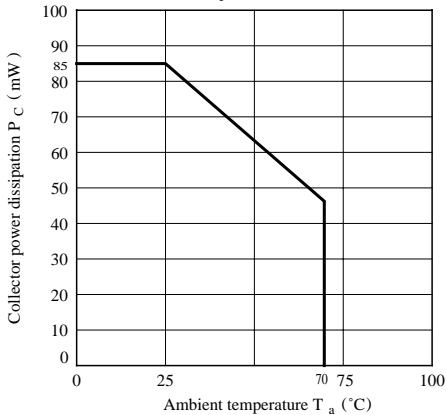


Fig. 5 Forward Current vs. Forward Voltage

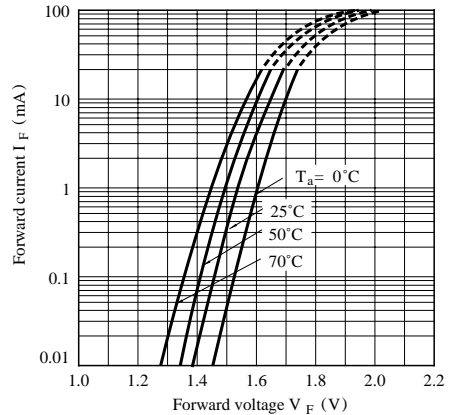


Fig. 6 High Level Output Current vs. Ambient Temperature

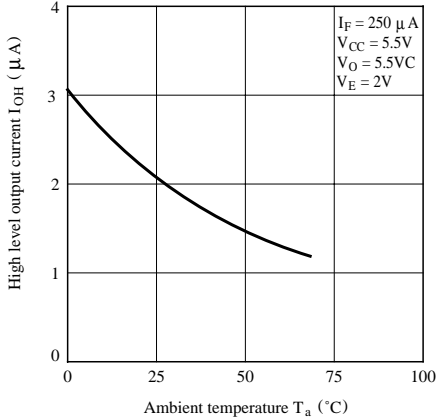


Fig. 7 Low Level Output Voltage vs. Ambient Temperature

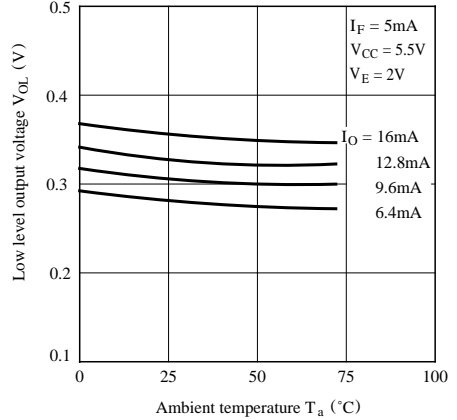


Fig. 8-a Output Voltage vs. Forward Current

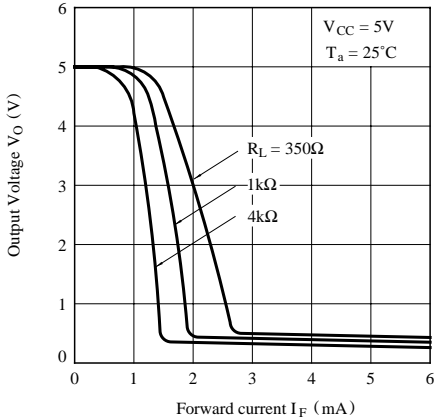


Fig. 8-b Output Voltage vs. Forward Current (Ambient Temp. Characteristics)

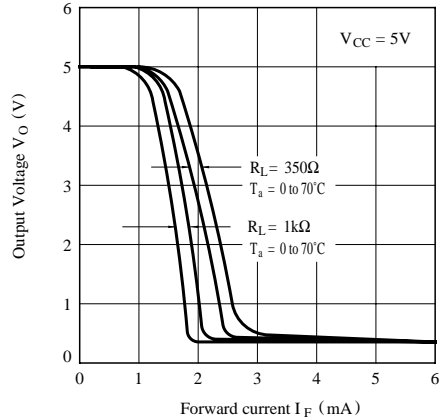


Fig. 9 Propagation Delay Time vs. Forward Current

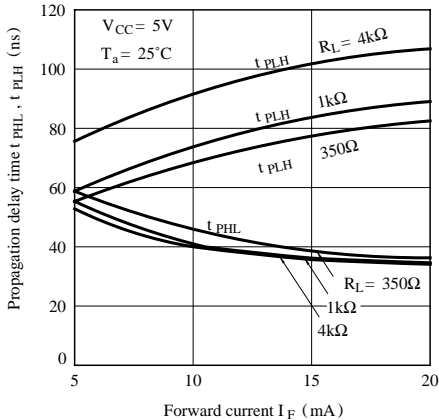


Fig.10 Propagation Delay Time vs. Ambient Temperature

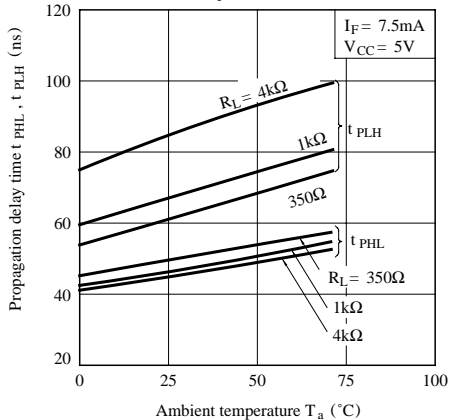


Fig.11 Rise Time, Fall Time vs. Ambient Temperature

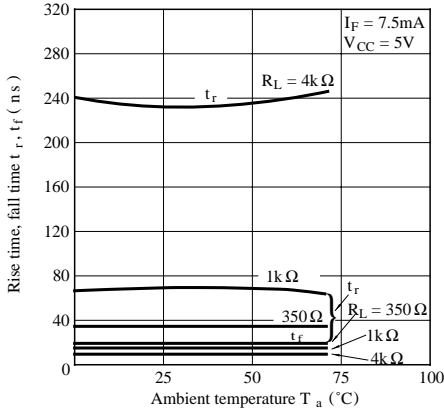
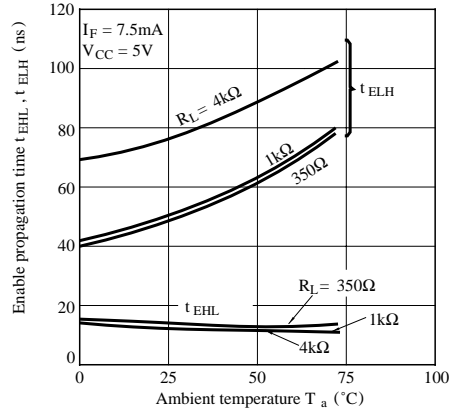


Fig.12 Enable Propagation Time vs. Ambient Temperature



■ Precautions for Use

- Handle this product the same as with other integrated circuits against static electricity.
- Please refer to the chapter “Precautions for Use” .